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(54) **SURFACE ACOUSTIC WAVE DEVICE**

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ABSTRACT

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A surface acoustic wave device according to the present disclosure includes a support substrate; an intermediate layer laminated on the support substrate; a piezoelectric layer laminated on the intermediate layer; and an IDT electrode formed on the piezoelectric layer, an Euler angle of the support substrate is $(-45^\circ \pm 10^\circ, -54^\circ \pm 10^\circ, 180^\circ \pm 30^\circ)$ and an Euler angle of the piezoelectric layer is $(0^\circ \pm 5^\circ, 112.5^\circ \pm 22.5^\circ, 0^\circ \pm 5^\circ)$ or $(0^\circ \pm 5^\circ, -67.5^\circ \pm 22.5^\circ, 0^\circ \pm 5^\circ)$.

